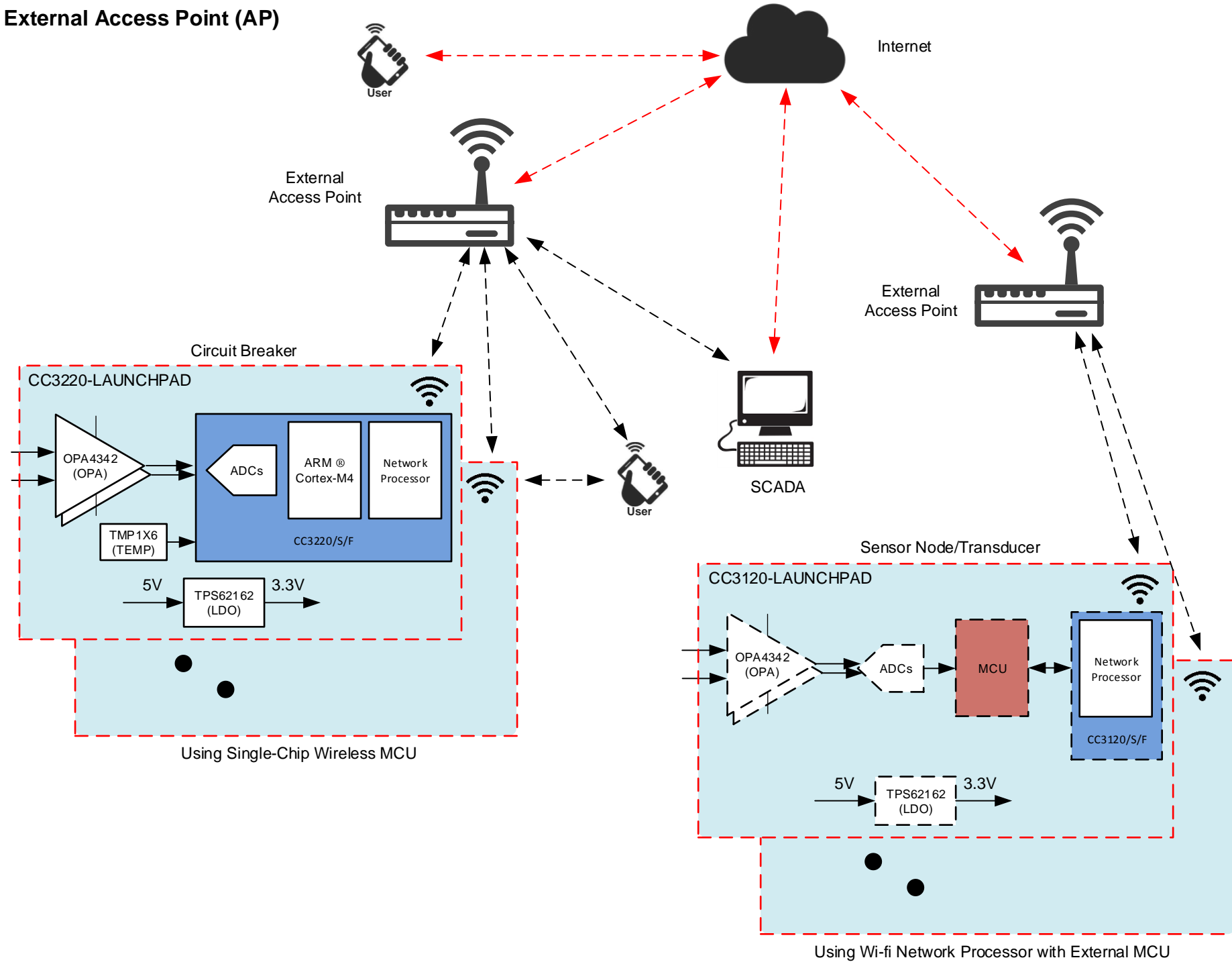
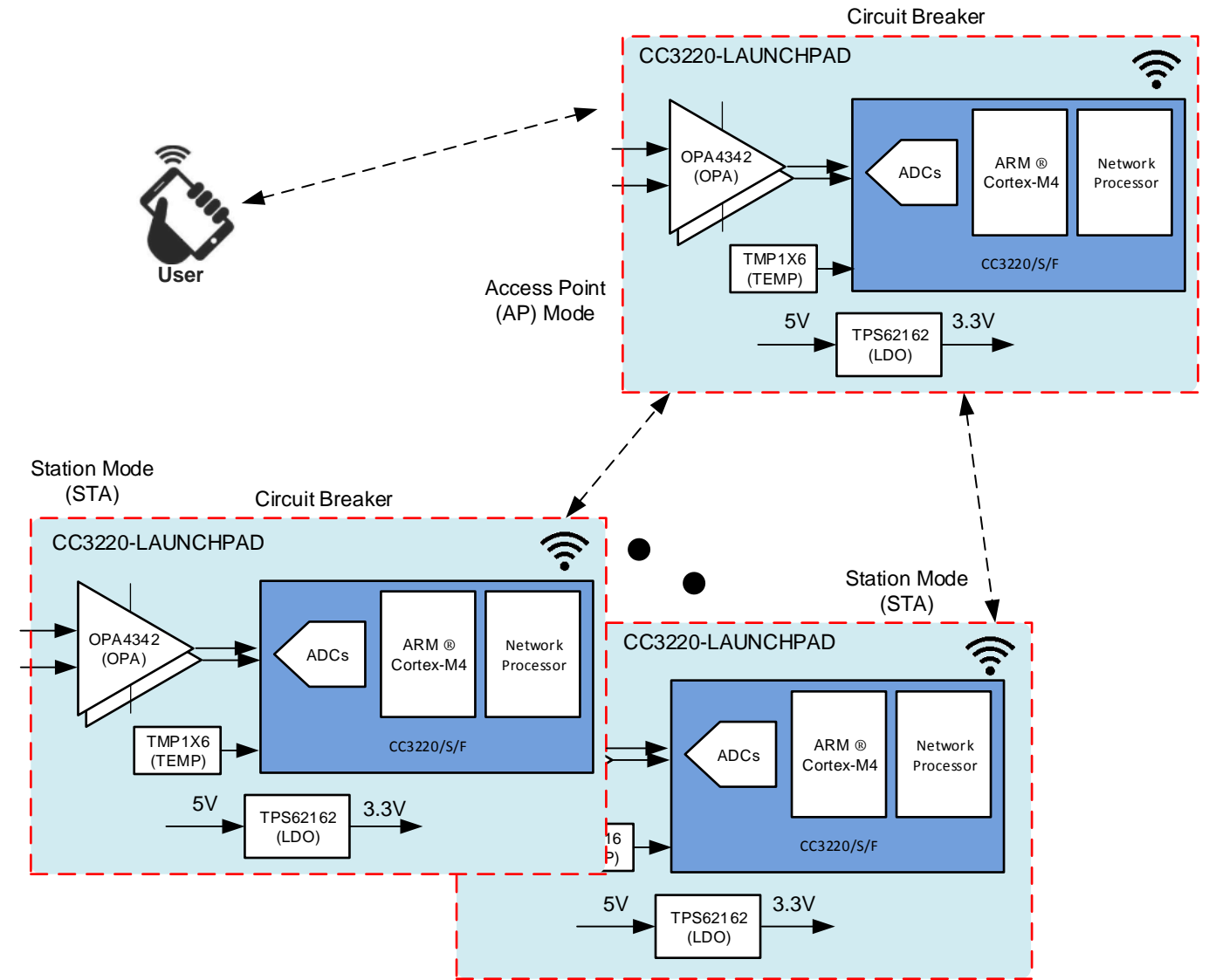


External Access Point (AP)



Device as Access Point (AP)



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